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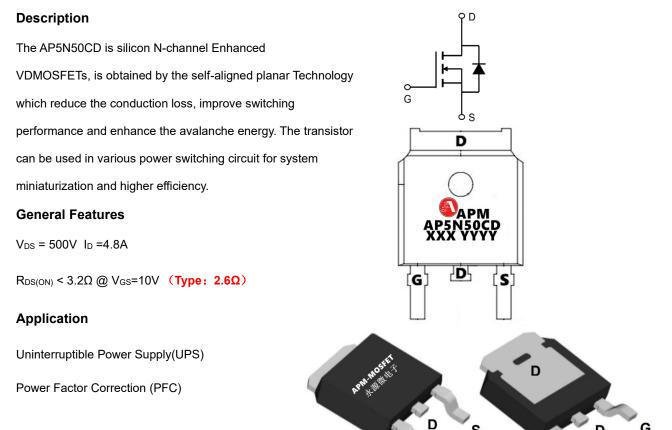
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500V N-Channel Enhancement Mode MOSFET

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Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
AP5N50CD	TO-252-3L	AP5N50CD XXX YYYY	2500

Absolute Maximum Ratings (Tc=25°C unless otherwise noted)

Symbol	Parameter	Value	Unit
VDSS	Drain-Source Voltage (VGS = 0V)	500	V
ID	Continuous Drain Current	4.8	A
IDM	Pulsed Drain Current (note1)	15	A
VGS	Gate-Source Voltage	±30	V
EAS	Single Pulse Avalanche Energy (note2)	57	mJ
IAR	Avalanche Current (note1)	2.4	A
EAR	Repetitive Avalanche Energy note1)	6.4	mJ
PD	Power Dissipation (TC = 25°C)	32.9	W
TJ, Tstg	Operating Junction and Storage Temperature Range	-55~+150	°C
RthJC	Thermal Resistance, Junction-to-Case	6.25	°C/W
RthJA	Thermal Resistance, Junction-to-Ambient	62.5	°C/W



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Symbol	Parameter	Test Conditions	Min	Тур	Мах	Unit
V(BR)DSS	Drain-Source Breakdown Voltage	V _{GS} = 0V, I _D = 250µA	500	550		V
IDSS	Zero Gate Voltage Drain Current	V _{DS} = 650V, V _{GS} = 0V, T _J =25°C			1	μA
IGSS	Gate-Source Leakage	$V_{GS} = \pm 30V$			±100	nA
VGS(th)	Gate-Source Threshold Voltage	V _{DS} = V _{GS} , I _D = 250µA	2.0	3.0	4.0	V
RDS(on)	Drain-Source On-Resistance (Note3)	V _{GS} = 10V, I _D = 2.0A		2.6	3.2	Ω
Ciss	Input Capacitance			310		
C _{oss}	Output Capacitance	V _{GS} = 0V, V _{DS} = 25V, f = 1.0MHz		39		pF
Crss	Reverse Transfer Capacitance			6		
Qg	Total Gate Charge			8		
Q_gs	Gate-Source Charge	V _{DD} =400V, I _D = 3A, V _{GS} = 10V		1.2		nC
Q_gd	Gate-Drain Charge			5		
td(on)	Turn-on Delay Time			7.8		
tr	Turn-on Rise Time	$V_{1-} = 250V_{1-} = 24$ D ₁ = 250		33		
td(off)	Turn-off Delay Time	V_{DD} =250V, I_D = 3A, R_G = 25 Ω		23		ns
t _f	Turn-off Fall Time			59		
IS	Continuous Body Diode Current	T _C = 25 °C			3.0	А
ISM	Pulsed Diode Forward Current	10 - 20 0			12	А
Vsd	Body Diode Voltage	T _J = 25°C, I _{SD} = 3A, V _{GS} = 0V			1.4	V
trr	Reverse Recovery Time	V _{GS} = 0V,I _S = 3A, di⊧/dt =100A		80		ns
Qrr	Reverse Recovery Charge	/µs		1.8		μC

Electrical Characteristics (T_J=25°C, unless otherwise noted)

Note :

1、The data tested by surface mounted on a 1 inch2 FR-4 board with 2OZ copper.

2、The EAS data shows Max. rating . IAS = 2.4A, VDD = 50V, RG = 25 Ω , Starting TJ = 25 °C

3、The test condition is Pulse Test: Pulse width \leq 300µs, Duty Cycle \leq 1%

4. The power dissipation is limited by 150 $^\circ\!\mathrm{C}$ junction temperature

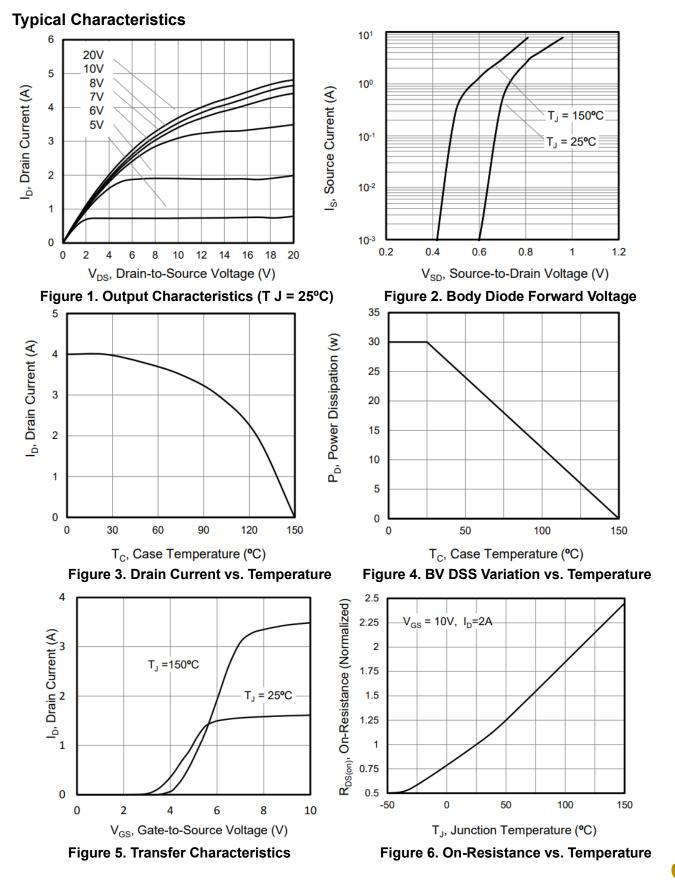
5、The data is theoretically the same as ID and IDM, in real applications, should be limited by total power dissipation.

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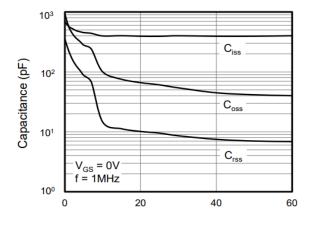


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V_{DS}, Drain-to-Source Voltage (V)



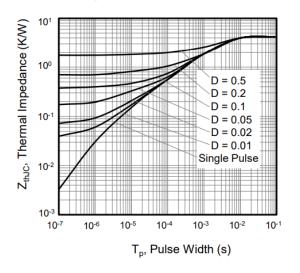


Figure 9. Transient Thermal Impedance

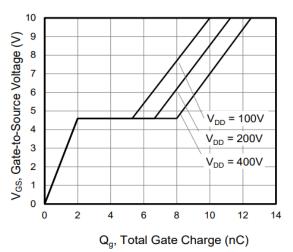
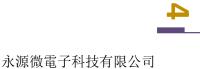


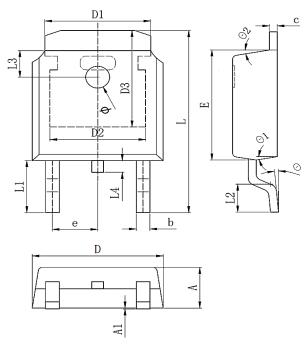
Figure 8. Gate Charge





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Package Mechanical Data-TO-252-3L



0. male al	Dim in mm			
Symbol	Min	Тур	Max	
A	2.1	2.3	2.5	
A1	0	0.064	0.128	
b	0.64	0.75	0.86	
С	0.45	0.52	0.6	
D	6.4	6.6	6.8	
D1	5.33REF			
D2	4.83REF			
D3	5.25REF			
E	5.9	6.1	6.3	
e	2.286TYP			
L	9.8	10.1	10.4	
L1	2.888REF			
L2	1.4	1.5	1.7	
L3	1.65REF			
L4	0.6	0.8	1	
φ	1.1	1.2	1.3	
θ	0°		10°	
θ1	5°		10°	
θ2	5°		10°	



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Edition	Date	Change
REV1.0	2023/4/31	Initial release

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